



## Material Content Data Sheet



Sales Product Name	TLI4961-1M			Issued		11. December 2019		
MA#	MA005403850							
Package	PG-SOT23-3-15			Weight*		9.82 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	0.350	3.56	3.56	35596	35596
leadframe	inorganic material	silicon	7440-21-3	0.001	0.01		73	
	non noble metal	titanium	7440-32-6	0.004	0.04		367	
	non noble metal	chromium	7440-47-3	0.011	0.11		1101	
	non noble metal	copper	7440-50-8	3.590	36.56	36.72	365603	367144
wire	noble metal	gold	7440-57-5	0.018	0.19	0.19	1854	1854
encapsulation	organic material	carbon black	1333-86-4	0.054	0.55		5463	
	plastics	epoxy resin	-	1.153	11.75		117459	
	inorganic material	silicondioxide	60676-86-0	4.157	42.33	54.63	423398	546320
leadfinish	non noble metal	tin	7440-31-5	0.150	1.52	1.52	15241	15241
plating	noble metal	silver	7440-22-4	0.149	1.51	1.51	15133	15133
glue	plastics	epoxy resin	-	0.032	0.33		3275	
	noble metal	silver	7440-22-4	0.152	1.54	1.87	15437	18712
*deviation	< 10%	Sum in total:			100.00		1000000	

### Important Remarks:

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3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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